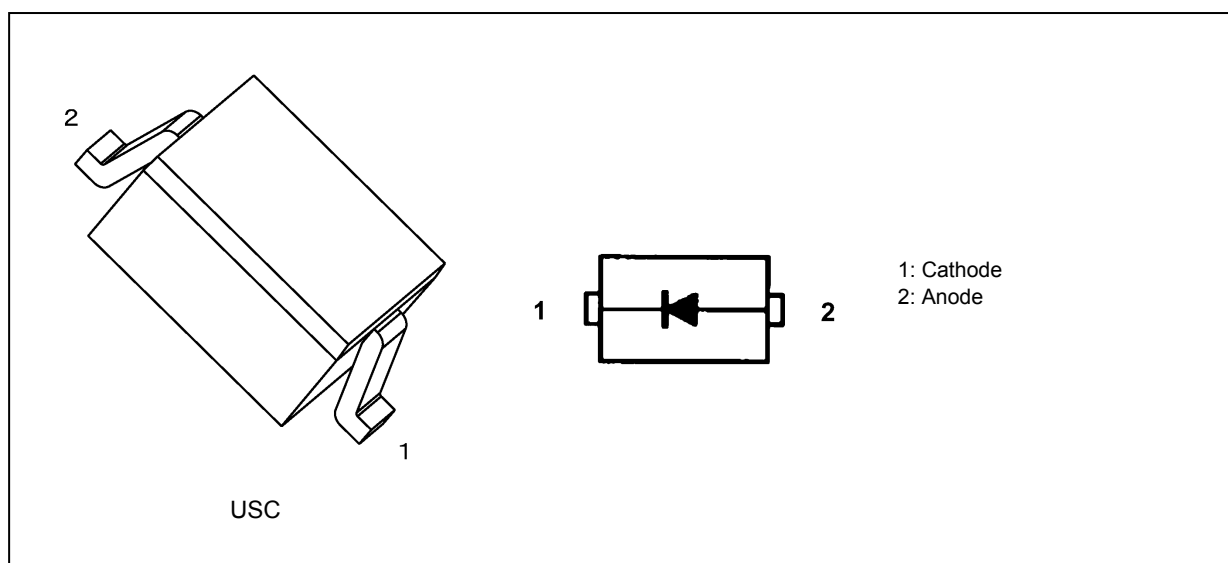


# CUS10S30

## 1. Applications

- High-Speed Switching

## 2. Packaging and Internal Circuit



## 3. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	$V_{RM}$		30	V
Reverse voltage	$V_R$		20	
Average rectified current	$I_O$	(Note 1)	1.0	A
Non-repetitive peak forward surge current	$I_{FSM}$	(Note 2)	5	
Junction temperature	$T_J$		125	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$		-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Mounted on an FR4 board.

(25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 645 mm<sup>2</sup>)

Note 2: Measured with a 10 ms pulse.

Start of commercial production

2013-09

#### 4. Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward voltage	$V_F(1)$	$I_F = 0.1\text{ A}$ (Pulse test)	—	0.23	—	V
Forward voltage	$V_F(2)$	$I_F = 0.5\text{ A}$ (Pulse test)	—	0.31	—	V
Forward voltage	$V_F(3)$	$I_F = 1\text{ A}$ (Pulse test)	—	0.37	0.45	V
Reverse current	$I_R$	$V_R = 30\text{ V}$ (Pulse test)	—	0.2	0.5	mA
Total capacitance	$C_t$	$V_R = 0\text{ V}$ , $f = 1\text{ MHz}$	—	135	—	pF

#### 5. Marking

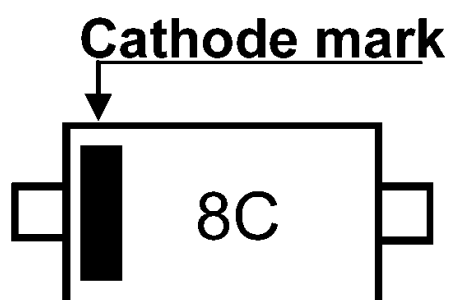


Fig. 5.1 Marking

Marking Code	Part Number
8C	CUS10S30

#### 6. Usage Considerations

- Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.

#### 7. Land Pattern Dimensions (for reference only)

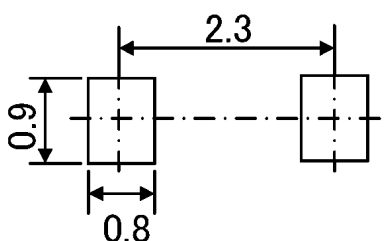


Fig. 7.1 Land Pattern Dimensions for Reference Only (Unit: mm)

## 8. Characteristics Curves (Note)

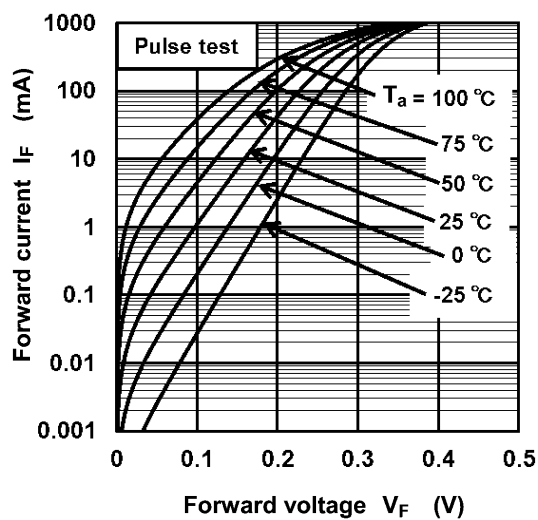


Fig. 8.1  $I_F - V_F$

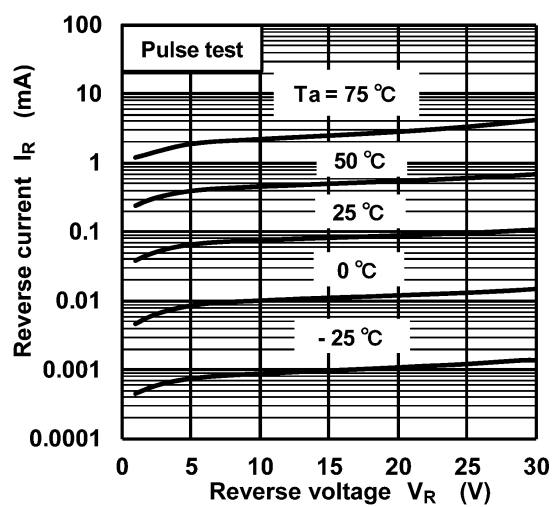


Fig. 8.2  $I_R - V_R$

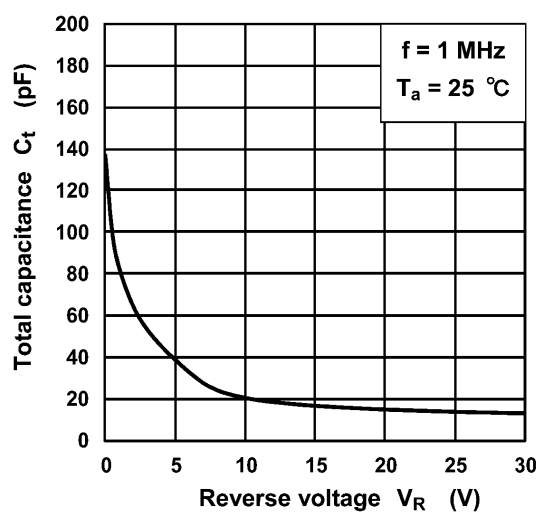
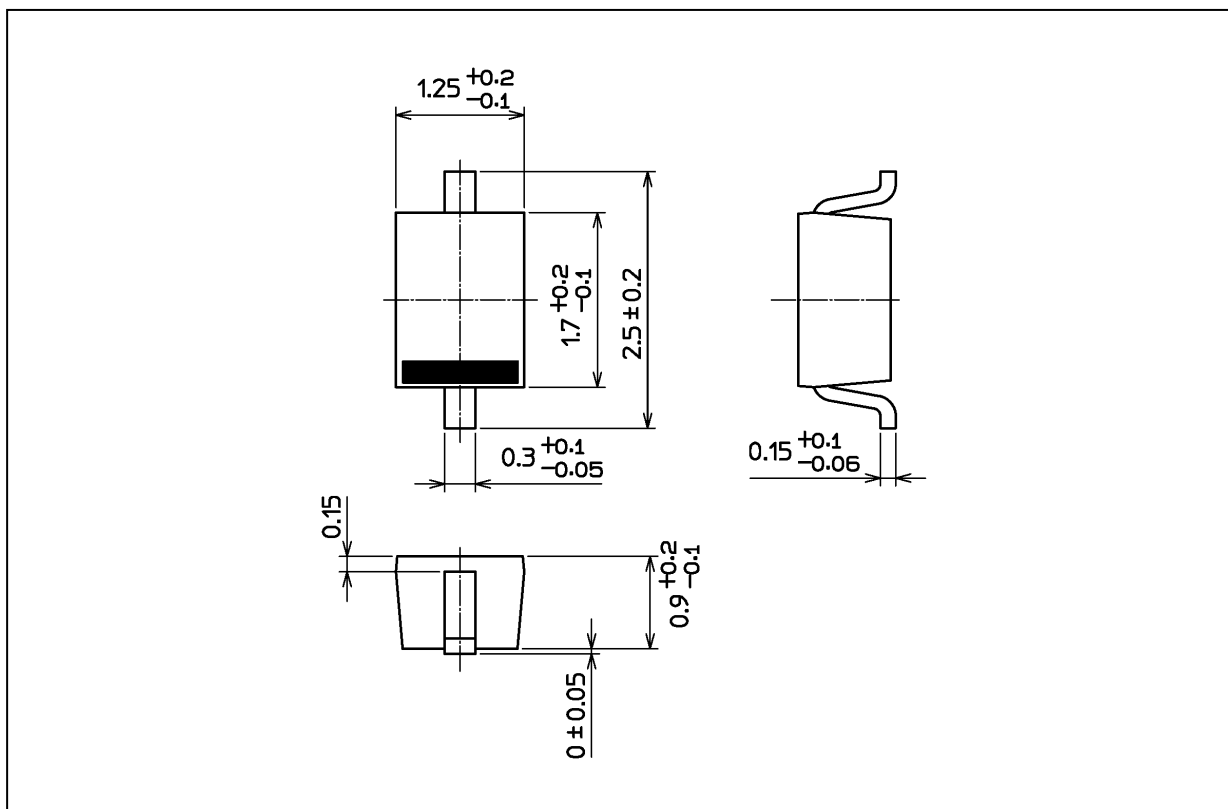


Fig. 8.3  $C_t - V_R$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## Package Dimensions

Unit: mm



Weight: 4.5 mg (typ.)

Package Name(s)
TOSHIBA: 1-1E1S
Nickname: USC

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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
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